

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appln. No: 10/518,194  
Applicant: Fumiyasu Nomura et al.  
Filed: September 20, 2005  
Title: METHOD FOR MANUFACTURING PLATED FILM, CATHODE ROLL FOR  
PLATING, AND METHOD FOR MANUFACTURING CIRCUIT BOARD  
TC/A.U.: 1795  
Examiner: Edna Wong  
Docket No.: TOR-104US

**AMENDMENT UNDER 37 C.F.R. § 1.116**  
**Expedited Procedure**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Responsive to the Final Office Action dated May 14, 2009, please amend the above-identified application as follows:

- Amendments to the Specification** begin on page \_\_\_\_\_ of this paper.
- Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.
- Amendments to the Drawings** begin on page 7 of this paper and include an attached replacement sheet.
- Amendments to the Abstract** are on page \_\_\_\_\_ of this paper. A clean version of the Abstract is on page \_\_\_\_\_ of this paper.
- Remarks/Arguments** begin on page 5 of this paper.